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3. (Amended) A cleaning method of an electronic component according to claim 1, wherein said sponge member is separated from said object to be cleaned during cleaning, and said water is supplied also to said separated sponge member.

Sub B1
A3
10. (Amended) A cleaning method of an electronic component according to any one of claims 1, 3, 5 or 7 to 9, wherein said object to be cleaned is soaked in water having a resistivity value of $10\text{M}\Omega$ or less before cleaning.